RM1D



DC switching solid state relays



Main features

- · Low power dissipation output MOSFET
- 100 ADC maximum output current up to 60 VDC
- 50 ADC maximum output current up to 200 VDC
- 10 ADC maximum output current up to 500 VDC
- Switching frequency up to 1000 Hz
- · 4-32 VDC control voltage range
- · LED for control presence indication
- Clip-on IP 20 protection cover
- Self-lifting terminals
- · Housing free of moulding mass

Description

The **RM1D** series expands Carlo Gavazzi's range of DC solid state switching solutions up to 100 A for supply voltages up to 60 VDC, up to 50 A for supply voltages of maximum 200 VDC and up to 10 A for supply voltages of maximum 500 VDC. This new range is suitable for panel mounting or for mounting on a heatsink. The switching of the **RM1D** is controlled by a DC voltage in the range of 4 to 32 V. An LED indicates control voltage presence on the SSR.

The **RM1D** is the ideal solution when switching response times, from ON to OFF and vice versa, are critical to the application. Being fully solid state, the **RM1D** is the obvious choice for applications necessitating a high number of switching cycles since the SSR lifetime is not compromised by such switching.

Specifications are at a surrounding temperature of 25°C unless otherwise specified.

Applications

DC heaters, solenoid valves, test equipment, connection and disconnection of battery sources.

Main functions

- DC switching solid state relay with 3750 Vrms isolation between input and output
- · Fast response times to switch ON and OFF
- · Fully solid state to ensure trouble free operation over a high number of switching cycles



Order code

🖅 RM1D 🗖 D 🗀

Enter the code option instead of . Refer to selection guide section for valid part numbers.

Code	Option	Description	Comments
R	-	Calid state valey (DM)	
M	-	Solid state relay (RM)	
1	-	1-pole switching	
D	-	DC switching	
	060	Rated output voltage: 60 VDC (1-60 VDC)	
	200 Rated output voltage: 200 VDC (1-200 VDC)		
	500	Rated output voltage: 500 VDC (1-500 VDC)	
D	-	Control voltage: 4-32 VDC	4.5-32 VDC for RM1D200, RM1D500
	3	Max. rated current: 3 ADC	Available only with RM1D060D
	10	Max. rated current (with heatsink): 10 ADC	Not available with RM1D200D
	20	Max. rated current (with heatsink): 20 ADC	Not available with RM1D500D
	50	Max. rated current (with heatsink): 50 ADC	Not available with RM1D500D
	100	Max. rated current (with heatsink): 100 ADC	Available only with RM1D060D
HT	-	Pre- attached thermal pad	Option, available on request

Selection guide

Rated output	Control					
voltage	voltage	3 ADC	10 ADC	20 ADC	50 ADC	100 ADC
1-60 VDC	4-32 VDC	RM1D060D3	RM1D060D10	RM1D060D20	RM1D060D50	RM1D060D100
1-200 VDC	4 F 22 V/DC	-	-	RM1D200D20	RM1D200D50	-
1-500 VDC	4.5-32 VDC	-	RM1D500D10	-	-	-

^{*} Refer to Heatsink selection tables

Carlo Gavazzi compatible components

Purpose	Component name/code	Notes
Heatsinks	RHS	Heatsinks and fans
Screws kits for SSR mounting	SRWKITM5X10MM	Packing qty.: 20 pcs.
Fork terminals	RM635KP	Packing qty.: 10 pcs.
Touch protection covers	RMIP20	Packing qty.: 10 pcs.
Thermal pads	KK071CUT	Packing qty.: 50 pcs.

Further reading

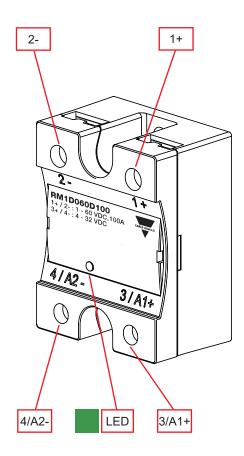
Information	Where to find it				
Heatinsk selector tool (online)	https://www.gavazziautomation.com/nsc/HQ/EN/heat_sink_selector_tool				
Output protection calculator tool (online)*	http://gavazziautomation.com/images/PIM/OTHERSTUFF/SOFTWARE/RM1D-Output%20protection%20calculator.zip				

^{*} Further details can be found in the Connection diagrams section on page 18





Structure



Element	Component	Function
1+	Power connection	Load connection or positive supply connection
2-	Power connection	Load connection or ground supply connection
3/A1+	Control connection	Control supply signal
4/A2-	Control connection	Ground connection for control
LED	Control indication	Indicates presence of control voltage

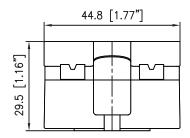


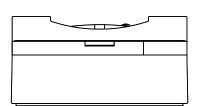
Features

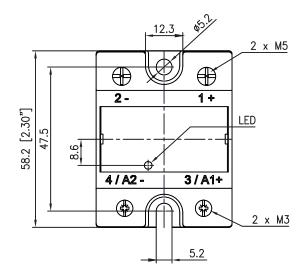
General data

Housing material	Noryl, black
Mounting	Panel mount
Touch protection	IP20
Isolation	Input and output to case: 3750 Vrms Input to output: 3750 Vrms
Weight	approx. 83 g
LED indication	Continuously ON green LED when control input is applied

Dimensions







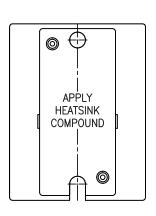


Fig. 1 RM1D dimensions

Dimensions in mm unless otherwise noted





Performance

Outputs

	RM1D060						
Max. operational current: DC 1 rating	3 ADC	10 ADC	20 ADC	50 ADC	100 ADC		
Absolute max. output voltage	60 VDC						
Operational voltage range, Ue	1-60 VDC						
Output protection			Integrated transil				
Leakage current @ rated voltage			0.1 mADC				
Minimum operational current	20 mADC		5 m/	ADC			
Repetitive overload current UL508: T_{AMB} =40°C, t_{ON} =1 s, t_{OFF} =9 s, 50 cycles	4.5 ADC	15 ADC 30 ADC 75 ADC 150 AI			150 ADC		

	RM1	RM1D500				
Max. operational current: DC 1 rating	20 ADC	50 ADC	10 ADC			
Absolute max. output voltage	200 '	500 VDC				
Operational voltage range, Ue	1-200 VDC	1-500 VDC				
Output protection	Integrated transil					
Leakage current @ rated voltage	0.1 mADC					
Minimum operational current		5 mADC				
Repetitive overload current UL508: T_{AMB} =40°C, t_{ON} =1 s, t_{OFF} =9 s, 50 cycles	30 ADC	75 ADC	15 ADC			

^{*} Please refer to note found in the Connection diagrams section

► Inputs

	RM1D060	RM1D200, RM1D500			
Control voltage range	4-32 VDC	4.5-32 VDC			
Pick-up voltage¹	4 VDC	4.5 VDC			
Drop-out voltage	1.2	VDC			
Maximum reverse voltage	32 VDC				
Maximum switching frequency ²	100) Hz			
Response time pickup $\text{@ V}_{\text{out}} = 24 \text{ VDC}, t_{\text{on}}^3$	≤100 µs				
Response time drop-out, t _{off} ³	≤100 µs	µs ≤150 μs			
Input current @ 40°C	<16 mADC				



Inputs (continued)

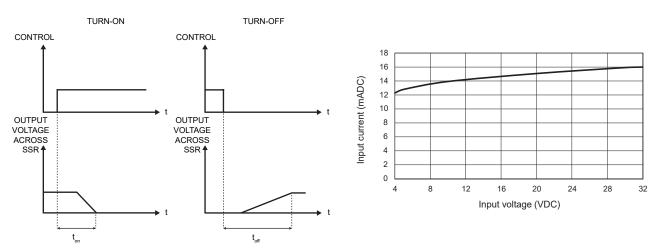


Fig. 2 Response time characteristics

Fig. 3 Input voltage vs. input current curve

- 1: Pick-up voltage increases to 5.5 VDC at operating temperatures lower than -20°C
- 2: Output current has to be derated at high switching frequencies. Refer to the Current derating vs. switching frequency
- 3: Response times will be longer for lower output voltages (<24 VDC)

Current derating vs switching frequency

RM1D060D..

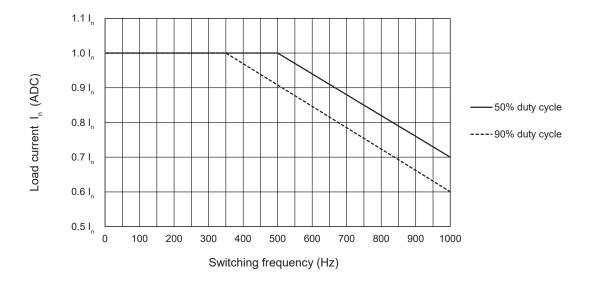


Fig. 4 Current derating vs. switching frequency



Current derating vs switching frequency (continued)

RM1D200D..



Fig. 5 Current derating vs. switching frequency4

RM1D500D..

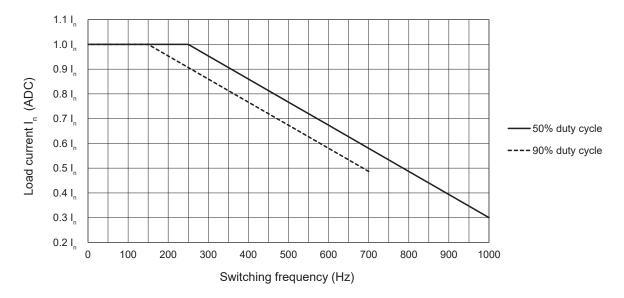


Fig. 6 Current derating vs. switching frequency4

- 4. At 90% duty cycle, the switching frequency for the RM1D200D.. and RM1D500D.. is limited to 700 Hz. This limitation is related to the response time drop out of 150 μ s for these models. For example:
 - OFF time at a switching frequency of 800Hz with 90% duty cycle is 125 μ s, that is lower than the time needed for the SSR to switch OFF (150 μ s) so the SSR output would not switch OFF
 - OFF time at a switching frequency of 600Hz with 90% duty cycle is 167 μ s which is greater than the time needed for the SSR to switch OFF (150 μ s)



Output power dissipation

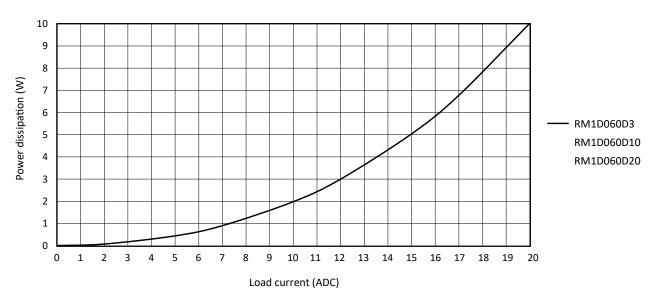


Fig. 7 Output power dissipation graph

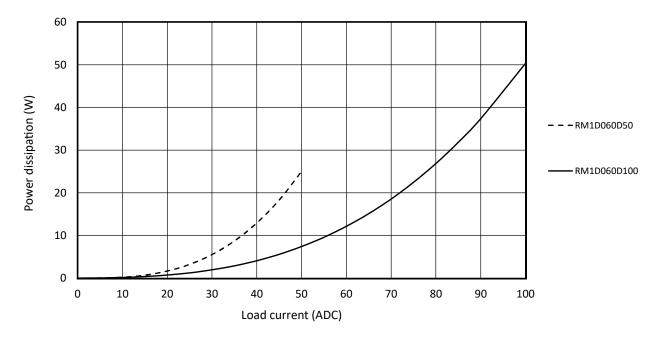


Fig. 8 Output power dissipation graph



Output power dissipation (continued)

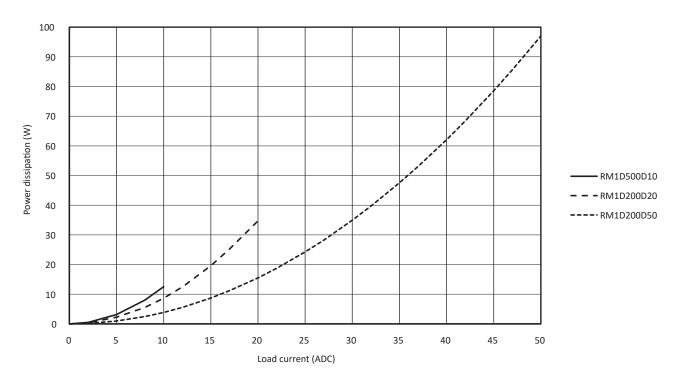


Fig. 9 Output power dissipation graph





Heatsink selection

Note: The heatsink selection in tables below is valid only when a fine layer of silicon based thermal paste (with a similar thermal resistance to that specified for R_{thcs} in the Thermal data section) is utilised. The SSR will overheat if this heatsink selection is used for heatsink assemblies using a thermal interface material having a higher R_{thcs} than indicated in the Thermal data section.

Thermal resistance [°C/W] of RM1D060D3, RM1D060D10, RM1D060D20

	Surrounding ambient temperature [°C]						
Load current [A]	20	30	40	50	60	70	80
20	nh	14.0	9.7	6.4	3.8	1.8	-
18	nh	nh	14.0	8.9	5.2	2.5	0.25
16	nh	nh	nh	13.3	7.5	3.5	0.51
14	nh	nh	nh	nh	11.4	5.1	0.92
12	nh	nh	nh	nh	nh	8.0	1.6
10	nh	nh	nh	nh	nh	14.3	2.7
8	nh	nh	nh	nh	nh	nh	5.0
6	nh	nh	nh	nh	nh	nh	11.5
4	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D060D50

	Surrounding ambient temperature [°C]						
Load current [A]	20	30	40	50	60	70	80
50	4.3	3.3	2.4	1.6	0.9	0.22	-
45	6.0	4.6	3.4	2.3	1.3	0.47	-
40	8.8	6.7	4.9	3.3	2.0	0.82	-
35	14.3	10.3	7.4	5.0	3.0	1.3	-
30	nh	18.7	12.3	8.0	4.7	2.2	0.18
25	nh	nh	nh	14.8	8.2	3.8	0.59
20	nh	nh	nh	nh	17.5	7.2	1.4
15	nh	nh	nh	nh	nh	18.5	3.2
10	nh	nh	nh	nh	nh	nh	10.3
5	nh	nh	nh	nh	nh	nh	nh

Note: 'nh' means no heatsink necessary. The SSR should still be tightened to a surface to ensure optimal thermal dissipation.





Heatsink selection (continued)

Thermal resistance [°C/W] of RM1D060D100

	Surrounding ambient temperature [°C]						
Load current [A]	20	30	40	50	60	70	80
100	1.8	1.4	1.1	0.73	0.4	-	-
90	2.4	1.9	1.5	1.0	0.6	0.21	-
80	3.3	2.7	2.0	1.4	0.88	0.37	-
70	4.8	3.8	2.9	2.1	1.3	0.61	-
60	7.6	5.9	4.4	3.1	2.0	0.98	-
50	14.0	10.2	7.4	5.1	3.2	1.6	0.27
40	nh	nh	15.5	9.9	5.9	2.9	0.64
30	nh	nh	nh	nh	14.2	6.3	1.5
20	nh	nh	nh	nh	nh	nh	4.2
10	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D200D20

	Surrounding ambient temperature [°C]						
Load current [A]	20	30	40	50	60	70	80
20	3.4	2.8	2.2	1.7	1.2	0.71	0.27
18	4.8	3.9	3.1	2.4	1.7	1.1	0.53
16	7.1	5.7	4.5	3.4	2.5	1.7	0.91
14	11.5	9.0	6.9	5.2	3.8	2.6	1.5
12	nh	16.1	11.7	8.5	6.1	4.1	2.4
10	nh	nh	nh	16.3	10.6	6.7	3.9
8	nh	nh	nh	nh	nh	13.5	7.0
6	nh	nh	nh	nh	nh	nh	17.5
4	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D200D50

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
50	1.1	1.0	0.79	0.60	0.42	0.24	-
45	1.6	1.4	1.1	0.86	0.62	0.39	0.17
40	2.3	1.9	1.6	1.2	0.92	0.62	0.33
35	3.4	2.8	2.3	1.8	1.4	1.0	0.55
30	5.3	4.4	3.5	2.8	2.1	1.5	0.92
25	9.3	7.5	5.9	4.6	3.4	2.4	1.5
20	nh	16.5	11.9	8.7	6.2	4.2	2.5
15	nh	nh	nh	nh	15.6	9.2	5.1
10	nh	nh	nh	nh	nh	nh	17.5
5	nh	nh	nh	nh	nh	nh	nh

Note: 'nh' means no heatsink necessary. The SSR should still be tightened to a surface to ensure optimal thermal dissipation.





Heatsink selection (continued)

Thermal resistance [°C/W] of RM1D500D10

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
10	10.7	8.3	6.4	4.7	3.3	2.2	1.1
9	17.0	12.6	9.4	6.8	4.8	3.1	1.7
8	nh	nh	14.8	10.4	7.2	4.6	2.6
7	nh	nh	nh	17.3	11.1	7.0	4.1
6	nh	nh	nh	nh	nh	11.3	6.1
5	nh	nh	nh	nh	nh	nh	10.2
4	nh	nh	nh	nh	nh	nh	nh
3	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh
1	nh	nh	nh	nh	nh	nh	nh

Note: 'nh' means no heatsink necessary. The SSR should still be tightened to a surface to ensure optimal thermal dissipation.



Heatsink selection for variants with pre-attached thermal pad

Note: The heatsink selection in tables below is valid for the models having a pre-attached thermal interface (RM1D..HT). The thermal resistance R_{thcs_HT} of the interface used is noted in the Thermal data section (ref. KK071CUT). In case of replacements, a thermal interface pad having the same or lower thermal resistance shall be utilised to prevent SSR from overheating.

Thermal resistance [°C/W] of RM1D060D3HT, RM1D060D10HT, RM1D060D20HT

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
20	nh	13.7	9.3	6.0	3.5	1.4	-
18	nh	nh	13.7	8.6	4.9	2.1	-
16	nh	nh	nh	12.9	7.1	3.1	0.16
14	nh	nh	nh	nh	11.0	4.7	0.57
12	nh	nh	nh	nh	19.8	7.6	1.2
10	nh	nh	nh	nh	nh	14.0	2.3
8	nh	nh	nh	nh	nh	nh	4.7
6	nh	nh	nh	nh	nh	nh	11.1
4	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh

Note: 'nh' means no heatsink necessary. The SSR should still be tightened to a surface to ensure optimal thermal dissipation.





► Heatsink selection for variants with pre-attached thermal pad (continued)

Thermal resistance [°C/W] of RM1D060D50HT

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
50	4.0	3.0	2.1	1.3	0.55	-	-
45	5.7	4.3	3.0	2.0	1.0	0.12	-
40	8.5	6.3	4.5	3.0	1.6	0.47	-
35	13.9	10.0	7.0	4.6	2.6	1.0	-
30	nh	18.3	12.0	7.6	4.4	1.9	-
25	nh	nh	nh	14.4	7.8	3.4	0.24
20	nh	nh	nh	nh	17.2	6.8	1.0
15	nh	nh	nh	nh	nh	18.2	2.9
10	nh	nh	nh	nh	nh	nh	10.0
5	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D060D100HT

	Surrounding ambient temperature [°C]						
Load current [A]	20	30	40	50	60	70	80
100	1.4	1.1	0.71	0.38	-	-	-
90	2.1	1.6	1.1	0.66	0.25	-	-
80	3.0	2.3	1.7	1.1	0.53	-	-
70	4.5	3.5	2.6	1.7	1.0	0.26	-
60	7.3	5.5	4.1	2.8	1.6	0.63	-
50	13.6	9.9	7.1	4.8	2.9	1.3	-
40	nh	nh	15.1	9.5	5.5	2.6	0.29
30	nh	nh	nh	nh	13.8	6.0	1.1
20	nh	nh	nh	nh	nh	nh	3.8
10	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D200D20HT

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
20	3.0	2.4	1.8	1.3	0.82	0.36	-
18	4.4	3.5	2.7	2.0	1.4	0.74	0.18
16	6.7	5.3	4.1	3.1	2.1	1.3	0.56
14	11.2	8.7	6.6	4.9	3.4	2.2	1.1
12	nh	16.2	11.7	8.4	5.8	3.7	2.1
10	nh	nh	nh	16.4	10.6	6.8	3.9
8	nh	nh	nh	nh	nh	13.7	7.1
6	nh	nh	nh	nh	nh	nh	17.7
4	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh

 $Note: 'nh'\ means\ no\ heatsink\ necessary.\ The\ SSR\ should\ still\ be\ tightened\ to\ a\ surface\ to\ ensure\ optimal\ thermal\ dissipation.$





Heatsink selection for versions with thermal pad (continued)

Thermal resistance [°C/W] of RM1D200D50HT

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
50	0.84	0.64	0.44	0.25	-	-	-
45	1.3	1.0	0.76	0.51	0.27	-	-
40	2.0	1.6	1.2	0.89	0.57	0.27	-
35	3.0	2.5	2.0	1.5	1.0	0.60	0.20
30	4.9	4.0	3.2	2.4	1.8	1.1	0.57
25	9.2	7.3	5.7	4.3	3.1	2.1	1.2
20	nh	16.5	12.0	8.7	6.2	4.2	2.5
15	nh	nh	nh	nh	15.7	9.3	5.2
10	nh	nh	nh	nh	nh	nh	17.8
5	nh	nh	nh	nh	nh	nh	nh

Thermal resistance [°C/W] of RM1D500D10HT

		Surrounding ambient temperature [°C]					
Load current [A]	20	30	40	50	60	70	80
10	10.4	8.0	6.0	4.4	3.0	1.8	0.76
9	16.8	12.3	9.0	6.5	4.4	2.8	1.4
8	nh	nh	14.8	10.1	6.8	4.3	2.3
7	nh	nh	nh	17.4	11.2	6.9	3.7
6	nh	nh	nh	nh	nh	11.4	6.1
5	nh	nh	nh	nh	nh	nh	10.4
4	nh	nh	nh	nh	nh	nh	nh
3	nh	nh	nh	nh	nh	nh	nh
2	nh	nh	nh	nh	nh	nh	nh
1	nh	nh	nh	nh	nh	nh	nh

Note: 'nh' means no heatsink necessary. The SSR should still be tightened to a surface to ensure optimal thermal dissipation.



Thermal data

	RM1D060D3 RM1D060D10 RM1D060D20 RM1D060D50	RM1D060D100	RM1D200D20	RM1D200D50	RM1D500D10
Max. junction temperature	175°C	175°C	150°C	150°C	150°C
Junction to case thermal resistance, R _{thjc}	1.2°C/W	0.6°C/W	0.9°C/W	0.45°C/W	1.5°C/W
Case to heatsink thermal resistance, R _{thcs} ⁵	0.2°C/W	0.2°C/W	0.1°C/W	0.1°C/W	0.2°C/W
Case to heatsink thermal resistance (RM1DHT), R _{thcs HT} ⁶	0.55°C/W	0.55°C/W	0.55°C/W	0.55°C/W	0.55°C/W

^{5:} Thermal resistance case to heatsink values are applicable upon application of a fine layer of silicon based thermal paste HTS02S from Electrolube between SSR and heatsink.

^{6:} Thermal resistance case to heatsink values for RM1D..HT are applicable for the KK071CUT thermal pad that is preattached from the factory to the RM1D.



Compatibility and conformance

Approvals	CECALUS ©* EHI CK
Standard compliance	LVD: EN 60947-1 EMCD: EN 61000-6-2, EN 61000-6-3 EE: EN 60947-1 EMC: EN 61000-6-2, EN 61000-6-3 cURus: UL508 Recognized (E80573), NRNT2, NRNT8 CSA: C22.2 No. 14 (204075)
UL short circuit current rating	5 kArms

^{*} not applicable to RM1D060D3

Electromagnetic compatibility (EMC) - Immunity					
Electrostatic discharge (ESD)	EN/IEC 61000-4-2 8 kV air discharge, 4 kV contact (PC2)				
Radiated radio frequency	EN/IEC 61000-4-3 10 V/m, from 80 MHz to 1 GHz (PC1) 10 V/m, from 1 GHz to 2.7 GHz (PC1)				
Electrical fast transient (burst)	EN/IEC 61000-4-4 Output 5 kHz, 100 kHz: 2 kV (PC2) Input 5 kHz, 100 kHz: 1 kV (PC2)				
Conducted radio frequency	EN/IEC 61000-4-6 10 V/m, from 0.15 to 80 MHz (PC1)				
Electrical surge	EN/IEC 61000-4-5 Output, line to line: 1 kV (PC2) Output, line to earth: 1 kV (PC2) Input, line to earth: 1 kV (PC2)				
Voltage dips	EN/IEC 61000-4-11 0% for 10, 20, 5000 ms (PC2) 40% for 200 ms (PC2) 70% for 500 ms (PC2) 80% for 5000 ms (PC2)				
Voltage dips, short interruptions and voltage variations	EN/IEC 61000-4-29 0% for 1, 3, 10, 30, 100, 300, 1000 ms (PC2) 30% for 10, 30, 100, 300, 1000 ms (PC2) 40% for 10, 30, 100, 300, 1000 ms (PC2) 60% for 10, 30, 100, 300, 1000 ms (PC2) 70% for 10, 30, 100, 300, 1000 ms (PC2) 80% on min. 19.2 VDC for 10, 30, 100, 300, 1000, 3000, 10000 ms (PC2) 120% on min. 29.8 VDC for 10, 30, 100, 300, 1000, 3000, 10000 ms (PC2)				

Electromagnetic compatibility (EMC) - Emissions				
Radio interference field emission (radiated) EN/IEC 55011 Class B: from 0.15 to 30 MHz				
Radio interference voltage emissions (conducted)	EN/IEC 55011 Class B: from 30 MHz to 1 GHz			

Note:

Control input lines must be installed together (i.e. a 2 core cable) to maintain products' susceptability to Radio Frequency interference

• Performance Criteria 1 (PC1): No degradation of performance or loss of function is allowed when the product is operated as

intended.

During the test, degradation of performance or partial loss of function is allowed. However when the test is complete the product should return operating as intended by itself. • Performance Criteria 2 (PC2):

Carlo Gavazzi Ltd. 15 18/01/2024 RM1D DS ENG



Environmental specifications

Operating temperature ⁷	-40°C to +80°C (-40°F to +176°F)
Storage temperature	-40°C to +100°C (-40°F to +212°F)
Relative humidity	95% non-condensing @ 40°C
Pollution degree	2
Installation altitude	0-1000 m. Above 1000 m derate linearly by 1% of FLC per 100 m up to a maximum of 2000 m
Vibration resistance	2g / axis
EU RoHS compliant	Yes
China RoHS	25

7. Refer to note 1 on page 6 with reference to pick-up voltage at temperatures below -20°C (-4°F).

The declaration in this section is prepared in compliance with People's Republic of China Electronic Industry Standard SJ/T11364-2014: Marking for the Restricted Use of Hazardous Substances in Electronic and Electrical Products.

	Toxic or Harardous Substances and Elements							
Part Name	Lead (Pb)	Mercury (Hg)	Polybromi- nated diphenyl ethers (PBDE)					
Power Unit Assembly	х	0	0	0	0	0		

O: Indicates that said hazardous substance contained in homogeneous materials fot this part are below the limit requirement of GB/T 26572.

X: Indicates that said hazardous substance contained in one of the homogeneous materials used for this part is above the limit requirement of GB/T 26572.

这份申明根据中华人民共和国电子工业标准

SJ/T11364-2014: 标注在电子电气产品中限定使用的有害物质

	有毒或有害物质与元素						
零件名称	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(Vl))	多溴化联苯 (PBB)	多溴联苯醚 (PBDE)	
功率单元	х	0	0	0	0	0	

O:此零件所有材料中含有的该有害物低于GB/T 26572的限定。

X: 此零件某种材料中含有的该有害物高于GB/T 26572的限定。



Short circuit protection

	Prophostivo	Ferraz Shawmut (Mersen)			Siba		
Part No.	Prospective short circuit current [kArms]	Max fuse size [A]	Part number	Voltage Rating [VDC]	Max fuse size [A]	Part number	Voltage Rating [VDC]
RM1D060D3		6	A4J6		6.3	5019006.6,3	
RM1D060D10		15	A4J15	300	16	5019006.16	660
RM1D060D20	5	25	A4J25		25	5019006.25	
RM1D060D50		70	A4J70		63	5019006.63	
RM1D060D100		125	A4J125		125	5019006.125	440
RM1D200D20		25	HSJ25		25	5019006.25	
RM1D200D50		70	HSJ70	500	63	5019006.63	660
RM1D500D10		15	HSJ15		16	5019006.16	



Connection diagrams

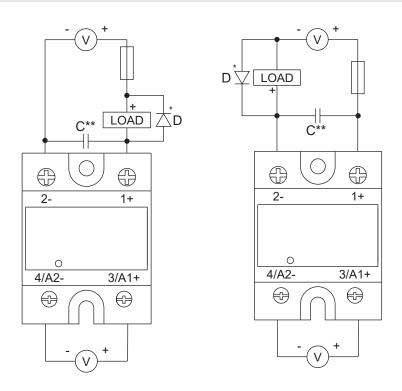


Fig. 10 RM1D connection diagrams

The wiring cables in a DC system act as an inductor and upon switching of the load, voltage transients exceeding the max. SSR voltage may result, leading to SSR damage. The RM1D output is protected with an internal transil, however, this internal component is not intended for repetitive operation as may happen in situations with repetitive voltage transients (for example with high switching frequencies). The internal transil will fail prematurely. Hence, for the **RM1D200D.** and **RM1D500D.** models, when used at switching frequencies >1Hz it is strongly recommended to connect capacitor C across the SSR output as shown in Fig. 10 to protect the SSR output from damages resulting from uncontrolled transients.

Capacitor C is not necessary (even at high switching frequencies) if the voltage transients can be controlled and cannot exceed the absolute maximum voltage rating of the SSR.

CAUTION!

Specifically for the **RM1D200D50**, if C is required due to high switching frequencies as explained above, the absolute maximum output voltage of the SSR shall be limited to 150 VDC.

Suggested C values can be calculated using the online Output protection calculator tool: http://gavazziautomation.com/images/PIM/OTHERSTUFF/SOFTWARE/RM1D-Output%20protection%20calculator.zip

^{*} A suppressor diode D is required for inductive loads.

^{**} Applicable only to RM1D200.. and RM1D500..



Functional diagram

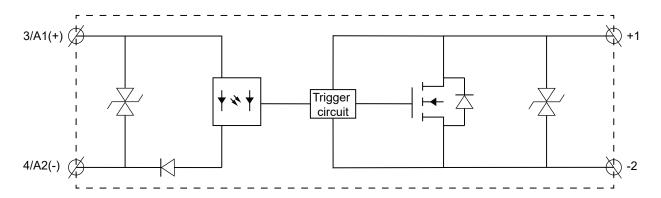


Fig. 11 RM1D functional diagram

Installation

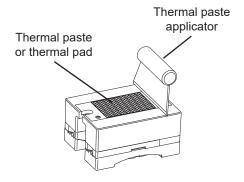


Fig. 12 A fine layer of thermally conductive silicone paste shall be evenly distributed to the base of the SSR before mounting on a heat dissipator. Alternatively a thermal pad may be used. The thermal interface material affects the thermal performance. Make sure that the heatsink is sized properly.

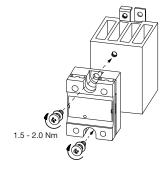


Fig. 13 Tighten screws alternately to 0.5 Nm and then continue to max. 2.0 Nm.

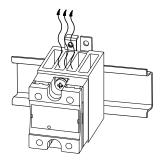


Fig. 14 Mount heatsink with fins in the vertical orientation to guarantee the best possible airflow through the heatsink.





Connection Specifications

	1+	, 2-	3/A1+, 4/A2-		
	Ţ.				
Mounting screws (SSR to heatsink)	M5, not provided with SSR (refer to SRWKITM5X10MM in the References section)				
Mounting torque (SSR to heatsink)	1.5 - 2.0 Nm (13.3	- 17.7 lb-in)			
Conductors	Use 75°C copper ((Cu) conductors	Use 60/75°C copper (Cu) conductors		
Stripping length, X	12 mm		8 mm		
Connection type	M5 screw with cap	otivated washer	M3 screw with captivated washer		
Rigid (solid & stranded) UR/CSA rated data	1x 2.5 - 6.0 mm ² 1x 14 - 10 AWG	2x 2.5 - 6.0 mm ² 2x 14 - 10 AWG	1x 0.5 - 2.5 mm ² 1x 18 - 12 AWG	2x 0.5 - 2.5 mm ² 2x 18 - 12 AWG	
Flexible with end sleeve	1x 1.0 - 4.0 mm ² 1x 18 - 12 AWG	2x 1.0 - 2.5 mm ² 2x 2.5 - 4.0 mm ² 2x 18 - 14 AWG 2x 14 - 12 AWG	1x 0.5 - 2.5 mm ² 1x 18 - 12 AWG	2x 0.5 - 2.5 mm ² 2x 18 - 12 AWG	
Flexible without end sleeve	1x 1.0 - 6.0 mm ² 1x 18 - 10 AWG	2x 1.0 - 2.5 mm ² 2x 2.5 - 6.0 mm ² 2x 18 - 14 AWG 2x 14 - 10 AWG	-	-	
Torque specifications	Pozidrive 2 2.4 Nm (21.2 lb-in)		Pozidrive 1 0.5 Nm (4.4 lb-in)		
Aperture for termination lug	12 mm		7.5 mm		



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